

HD74HC78

Dual J-K Flip-Flops

(with Preset, Common Clear and Common Clock)

REJ03D0553-0200 (Previous ADE-205-425) Rev.2.00 Oct 06, 2005

Description

This flip-flop is edge sensitive to the clock input and change state on the negative transition of the clock pulse. Each flip-flop has independent J, K, and preset inputs and Q and Q outputs. Two flip-flops are controlled by a common clear and a common clock. Preset and clear are independent of the clock and accomplished by a low logic level on the corresponding input.

Features

• High Speed Operation: t_{pd} (Clock to Q) = 20 ns typ (C_L = 50 pF)

• High Output Current: Fanout of 10 LSTTL Loads

• Wide Operating Voltage: $V_{CC} = 2$ to 6 V

• Low Input Current: 1 μA max

• Low Quiescent Supply Current: I_{CC} (static) = 2 μ A max (Ta = 25°C)

• Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74HC78FPEL	SOP-14 pin (JEITA)	PRSP0014DF-B (FP-14DAV)	FP	EL (2,000 pcs/reel)
HD74HC78RPEL	SOP-14 pin (JEDEC)	PRSP0014DE-A (FP-14DNV)	RP	EL (2,500 pcs/reel)

Note: Please consult the sales office for the above package availability.

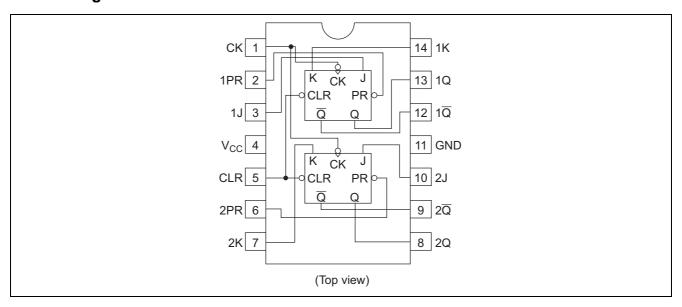
Function Table

		Out	puts				
Preset	Clear	Clock	J	K	Q	Q	
L	Н	Х	X	Х	Н	L	
Н	L	Х	X	Х	L	Н	
L	L	Х	X	Х	H ^{*1}	H ^{*1}	
Н	Н		L	L	No change		
Н	Н	_	L	Н	L	Н	
Н	Н		Н	L	Н	L	
Н	Н		Н	Н	Toggle		
Н	Н	L	X	Х	No change		
Н	Н	Н	Х	Х	No change		
Н	Н		Х	Х	No ch	nange	

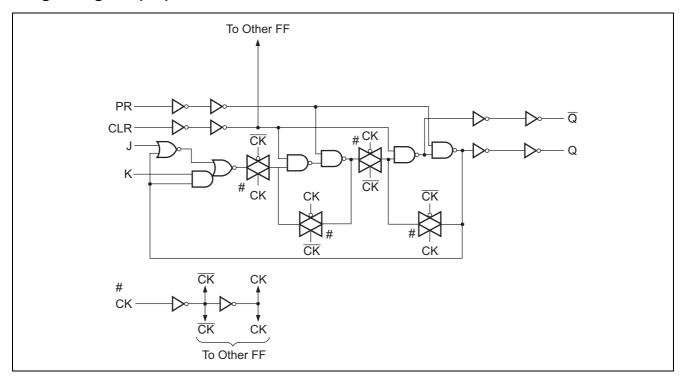
H: High levelL: Low levelX: Irrelevant

Note: 1. Q and \overline{Q} will remain High as long as Preset and Clear are Low, but Q and \overline{Q} are unpredictable, if Preset and Clear go High simultaneously.

Pin Arrangement



Logic Diagram (1/2)



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit
Supply voltage range	V _{CC}	-0.5 to 7.0	V
Input / Output voltage	Vin, Vout	-0.5 to V _{CC} +0.5	V
Input / Output diode current	I _{IK} , I _{OK}	±20	mA
Output current	Io	±25	mA
V _{CC} , GND current	I _{CC} or I _{GND}	±50	mA
Power dissipation	P _T	500	mW
Storage temperature	Tstg	-65 to +150	°C

Note: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

Recommended Operating Conditions

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V _{CC}	2 to 6	V	
Input / Output voltage	V _{IN} , V _{OUT}	0 to V _{CC}	V	
Operating temperature	Та	-40 to 85	°C	
		0 to 1000		V _{CC} = 2.0 V
Input rise / fall time ^{*1}	t_r, t_f	0 to 500	ns	$V_{CC} = 4.5 \text{ V}$
		0 to 400		$V_{CC} = 6.0 \text{ V}$

Note: 1. This item guarantees maximum limit when one input switches.

Waveform: Refer to test circuit of switching characteristics.

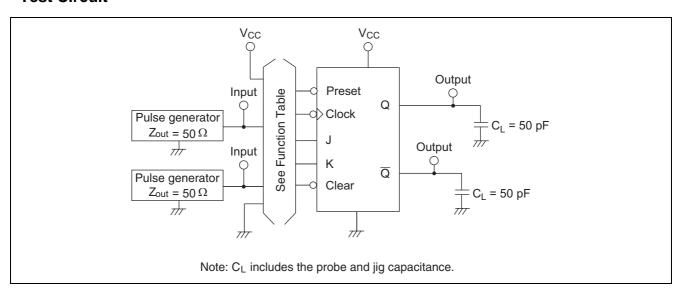
Electrical Characteristics

			Т	a = 25°	С	Ta = -40 to+85°C				
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Cor	nditions
Input voltage	V _{IH}	2.0	1.5	_	_	1.5	_	V		
		4.5	3.15	_	_	3.15	_			
		6.0	4.2	_	_	4.2	_			
	V_{IL}	2.0	_	_	0.5	_	0.5	V		
		4.5	_	_	1.35	_	1.35			
		6.0	_	_	1.8	_	1.8			
Output voltage	V_{OH}	2.0	1.9	2.0	_	1.9	_	V	$Vin = V_{IH} or V_{IL}$	$I_{OH} = -20 \mu A$
		4.5	4.4	4.5	_	4.4	_			
		6.0	5.9	6.0	_	5.9	_			
		4.5	4.18	_	_	4.13	_			$I_{OH} = -4 \text{ mA}$
		6.0	5.68	_	_	5.63	_			$I_{OH} = -5.2 \text{ mA}$
	V_{OL}	2.0	_	0.0	0.1	_	0.1	V	$Vin = V_{IH} or V_{IL}$	$I_{OL} = 20 \mu A$
		4.5	_	0.0	0.1	_	0.1			
		6.0	_	0.0	0.1	_	0.1			
		4.5	_	_	0.26	_	0.33			I _{OL} = 4 mA
		6.0	_	_	0.26	_	0.33			$I_{OL} = 5.2 \text{ mA}$
Input current	lin	6.0	_	_	±0.1	_	±1.0	μΑ	Vin = V _{CC} or GND	
Quiescent supply current	I _{CC}	6.0			2.0	_	20	μΑ	Vin = V_{CC} or GND, lout = 0 μ A	

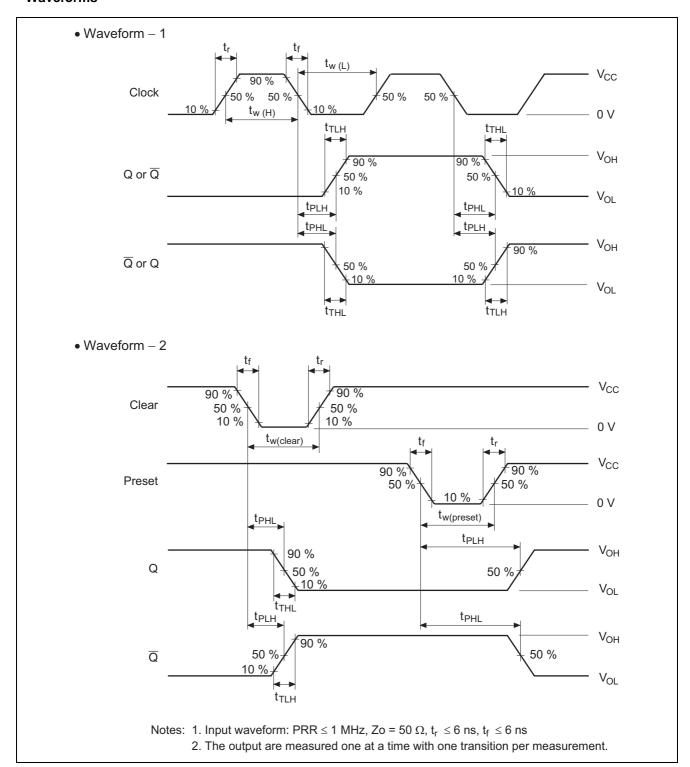
Switching Characteristics ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$)

			Ta = 25°C Ta = -40 to +85°		to +85°C				
Item	Symbol	V _{CC} (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Maximum clock	f _{max}	2.0	_	_	6	_	5	MHz	
frequency		4.5	_	_	30	_	24		
		6.0	_	_	35	_	28		
Propagation delay	t _{PLH} , t _{PHL}	2.0	_	_	150	_	190	ns	Clock to Q or Q
time		4.5	_	20	30	_	38		
		6.0	_	_	26	_	33		
		2.0	_	_	140	_	175	ns	Clear to Q or Q
		4.5	_	18	28	_	35		
		6.0	_	_	24	_	30		
		2.0	_	_	140	_	175	ns	Preset to Q or Q
		4.5	_	18	28	_	35		
		6.0	_	_	24	_	30		
Pulse width	t _w	2.0	80	_	_	100	_	ns	Preset, Clear, Clock
		4.5	16	8	_	20	_		
		6.0	14	_	_	17	_		
Setup time	t _{su}	2.0	100	_	_	125	_	ns	J or K to Clock
		4.5	20	2	_	25	_		
		6.0	17	_	_	21	_		
Hold time	t _h	2.0	5	_	_	5	_	ns	Clock to J or K
		4.5	5	-1	_	5	_		
		6.0	5	_	_	5	_		
Removal time	t _{rem}	2.0	100	_	_	125	_	ns	Preset or Clear to Clock
		4.5	20	0	_	25	_		
		6.0	17	_	_	21	_		
Output rise/fall	t _{TLH} , t _{THL}	2.0	_	_	75	_	95	ns	
time		4.5	_	5	15	_	19		
		6.0	_	_	13	_	16		
Input capacitance	Cin	_		5	10	_	10	рF	

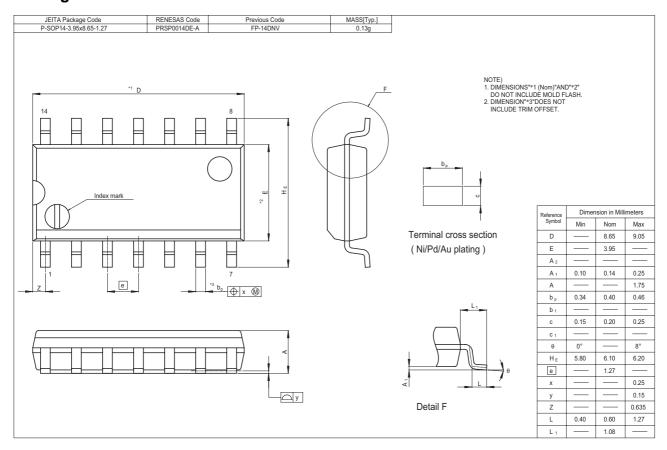
Test Circuit

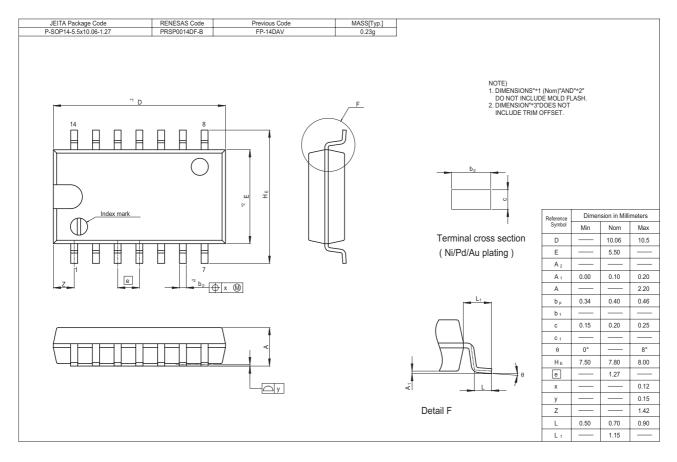


Waveforms



Package Dimensions





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